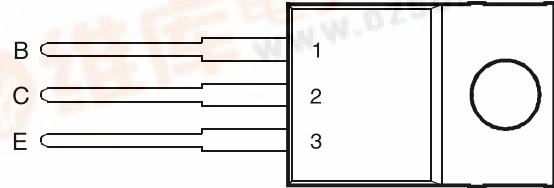




## BUL791 NPN SILICON POWER TRANSISTOR

- **Designed Specifically for High Frequency Electronic Ballasts up to 125 W**
- $h_{FE}$  6 to 22 at  $V_{CE} = 1\text{ V}$ ,  $I_C = 2\text{ A}$
- **Low Power Losses (On-state and Switching)**
- **Key Parameters Characterised at High Temperature**
- **Tight and Reproducible Parametric Distributions**

TO-220 PACKAGE  
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

### absolute maximum ratings at 25°C ambient temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-emitter voltage ( $V_{BE} = 0$ )	$V_{CES}$	700	V
Collector-base voltage ( $I_E = 0$ )	$V_{CBO}$	700	V
Collector-emitter voltage ( $I_B = 0$ )	$V_{CEO}$	400	V
Emitter-base voltage	$V_{EBO}$	9	V
Continuous collector current	$I_C$	4	A
Peak collector current (see Note 1)	$I_{CM}$	8	A
Peak collector current (see Note 2)	$I_{CM}$	14	A
Continuous base current	$I_B$	2.5	A
Peak base current (see Note 2)	$I_{BM}$	3.5	A
Continuous device dissipation at (or below) 25°C case temperature	$P_{tot}$	75	W
Operating junction temperature range	$T_j$	-65 to +150	°C
Storage temperature range	$T_{stg}$	-65 to +150	°C

NOTES: 1. This value applies for  $t_p = 10\text{ ms}$ , duty cycle  $\leq 2\%$ .  
2. This value applies for  $t_p = 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

# BUL791

## NPN SILICON POWER TRANSISTOR

### electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 3)	400			V
$I_{CES}$ Collector-emitter cut-off current	$V_{CE} = 700 \text{ V}$ $V_{CE} = 700 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$	$T_C = 90^\circ \text{ C}$			10 200	$\mu\text{A}$
$I_{EBO}$ Emitter cut-off current	$V_{EB} = 9 \text{ V}$	$I_C = 0$				1	mA
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 400 \text{ mA}$ $I_B = 400 \text{ mA}$	$I_C = 2 \text{ A}$ $I_C = 2 \text{ A}$	(see Notes 4 and 5) $T_C = 90^\circ \text{ C}$		0.94 0.86	1	V
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 400 \text{ mA}$ $I_B = 400 \text{ mA}$	$I_C = 2 \text{ A}$ $I_C = 2 \text{ A}$	(see Notes 4 and 5) $T_C = 90^\circ \text{ C}$		0.25 0.3	0.4	V
$h_{FE}$ Forward current transfer ratio	$V_{CE} = 1 \text{ V}$ $V_{CE} = 1 \text{ V}$ $V_{CE} = 5 \text{ V}$	$I_C = 10 \text{ mA}$ $I_C = 2 \text{ A}$ $I_C = 8 \text{ A}$		10 6 2	16.5 12 6.5	22 14	
$V_{FCB}$ Collector-base forward bias diode voltage	$I_{CB} = 60 \text{ mA}$				850		mV

NOTES: 3. Inductive loop switching measurement.

4. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts, and located within 3.2 mm from the device body.

### thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$
$R_{\theta JC}$ Junction to case thermal resistance			1.66	$^\circ\text{C/W}$

### inductive-load switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$t_{sv}$ Storage time	$I_C = 2 \text{ A}$ $L = 1 \text{ mH}$	$I_{B(on)} = 400 \text{ mA}$	$V_{CC} = 40 \text{ V}$		2.2	3	$\mu\text{s}$
$t_{fi}$ Current fall time		$I_{B(off)} = 800 \text{ mA}$	$V_{CLAMP} = 300 \text{ V}$		95	180	ns
$t_{xo}$ Cross over time					210	300	ns
$t_{sv}$ Storage time	$I_C = 2 \text{ A}$ $L = 1 \text{ mH}$	$I_{B(on)} = 400 \text{ mA}$	$V_{CC} = 40 \text{ V}$		4	6	$\mu\text{s}$
$t_{fi}$ Current fall time		$I_{B(off)} = 250 \text{ mA}$	$V_{CLAMP} = 300 \text{ V}$		120	230	ns

### resistive-load switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$t_{sv}$ Storage time	$I_C = 2 \text{ A}$ $V_{CC} = 300 \text{ V}$	$I_{B(on)} = 400 \text{ mA}$			2.2	3	$\mu\text{s}$
$t_{fi}$ Current fall time		$I_{B(off)} = 400 \text{ mA}$			160	250	ns

**TYPICAL CHARACTERISTICS**

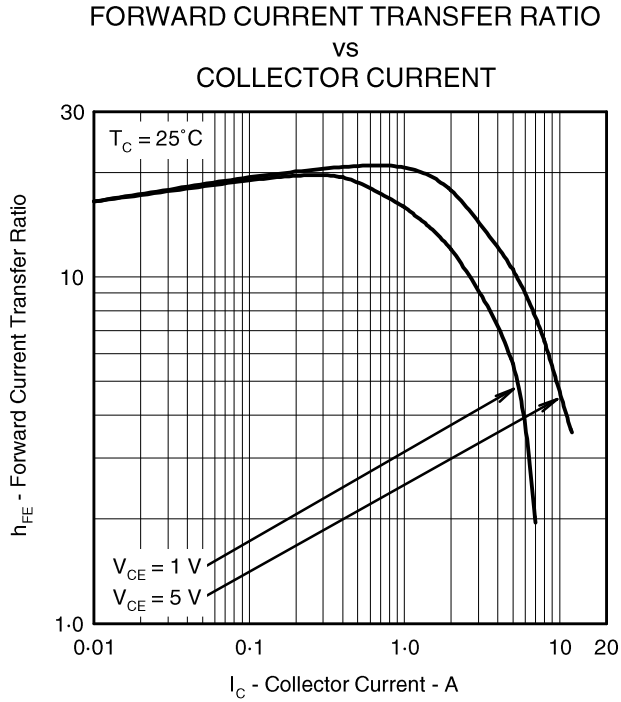


Figure 1.

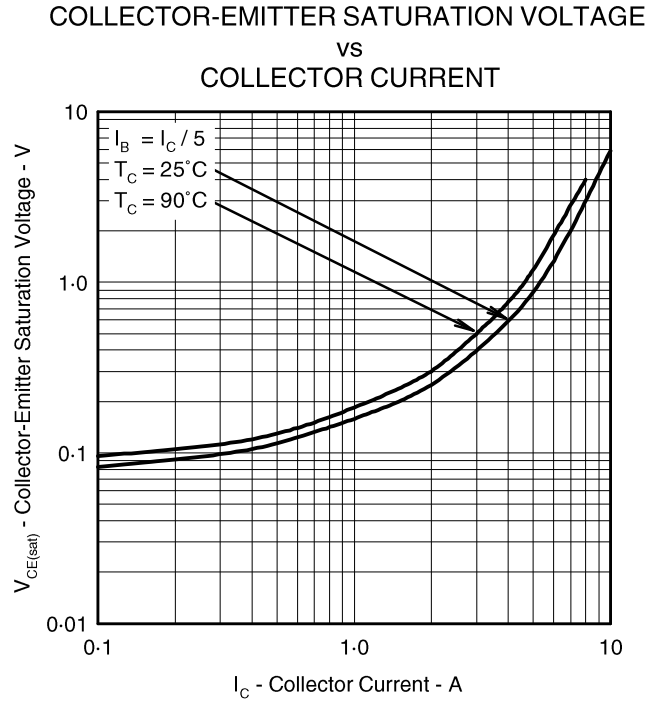


Figure 2.

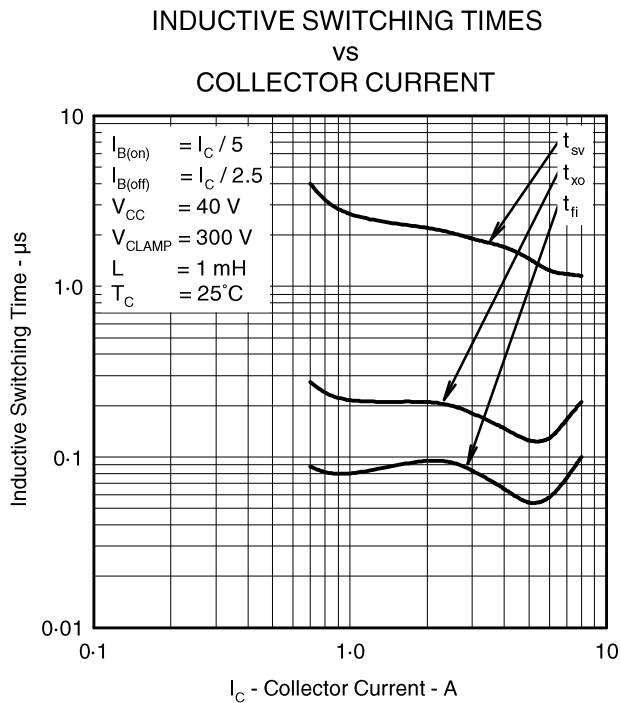


Figure 3.

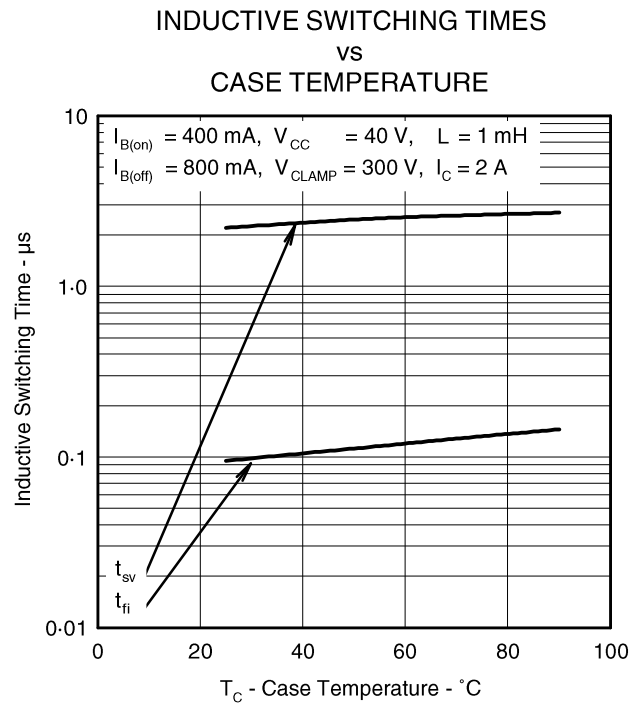


Figure 4.

**BUL791**  
**NPN SILICON POWER TRANSISTOR**

**TYPICAL CHARACTERISTICS**

INDUCTIVE SWITCHING TIMES  
 VS  
 COLLECTOR CURRENT

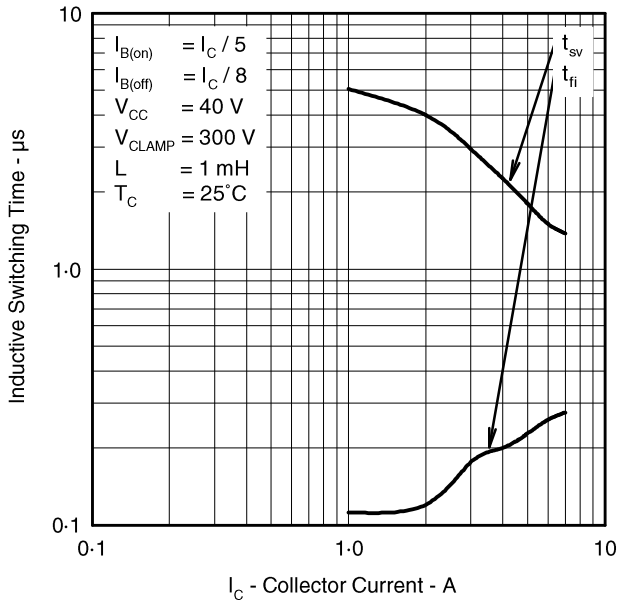


Figure 5.

INDUCTIVE SWITCHING TIMES  
 VS  
 CASE TEMPERATURE

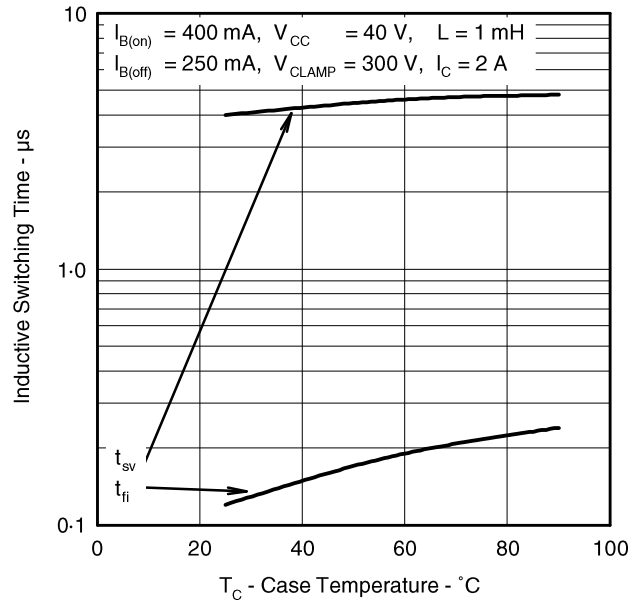


Figure 6.

RESISTIVE SWITCHING TIMES  
 VS  
 COLLECTOR CURRENT

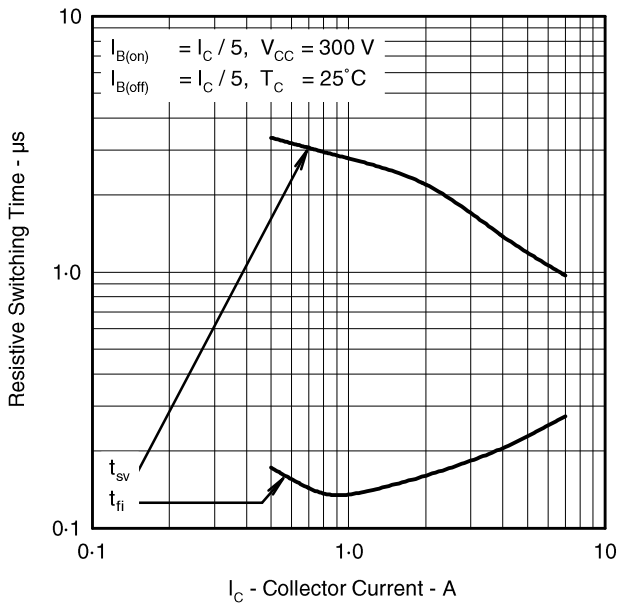


Figure 7.

RESISTIVE SWITCHING TIMES  
 VS  
 CASE TEMPERATURE

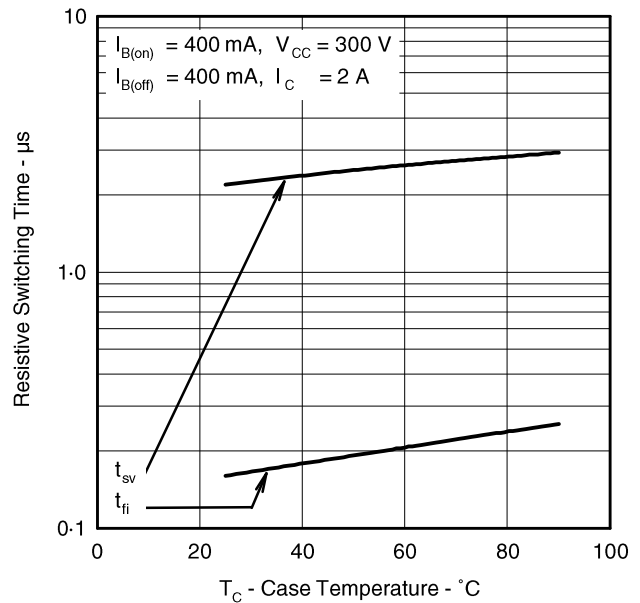


Figure 8.

MAXIMUM SAFE OPERATING REGIONS

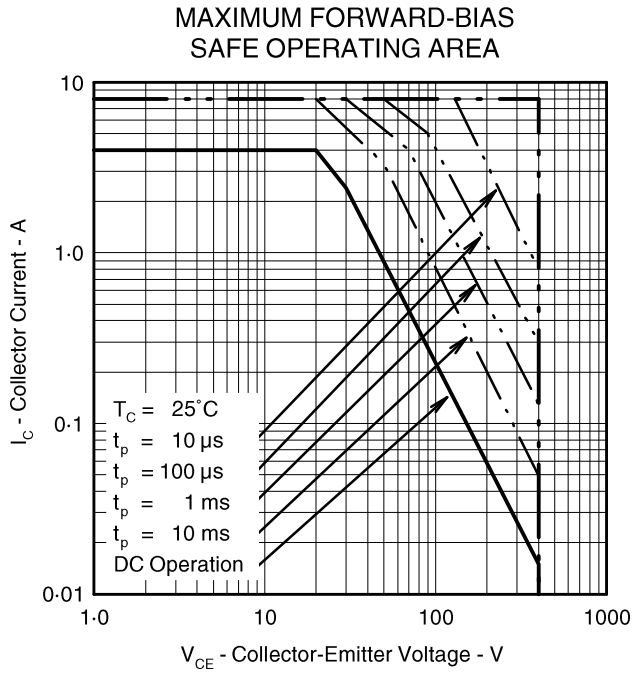


Figure 9.

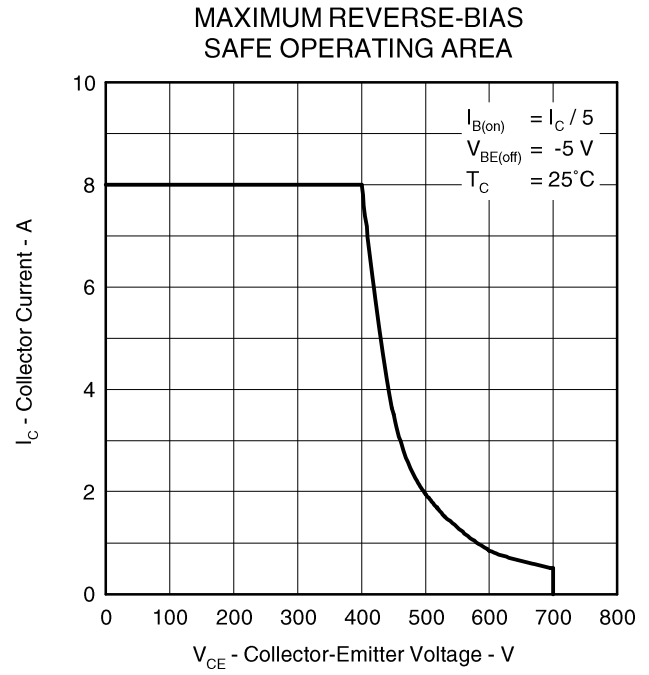


Figure 10.

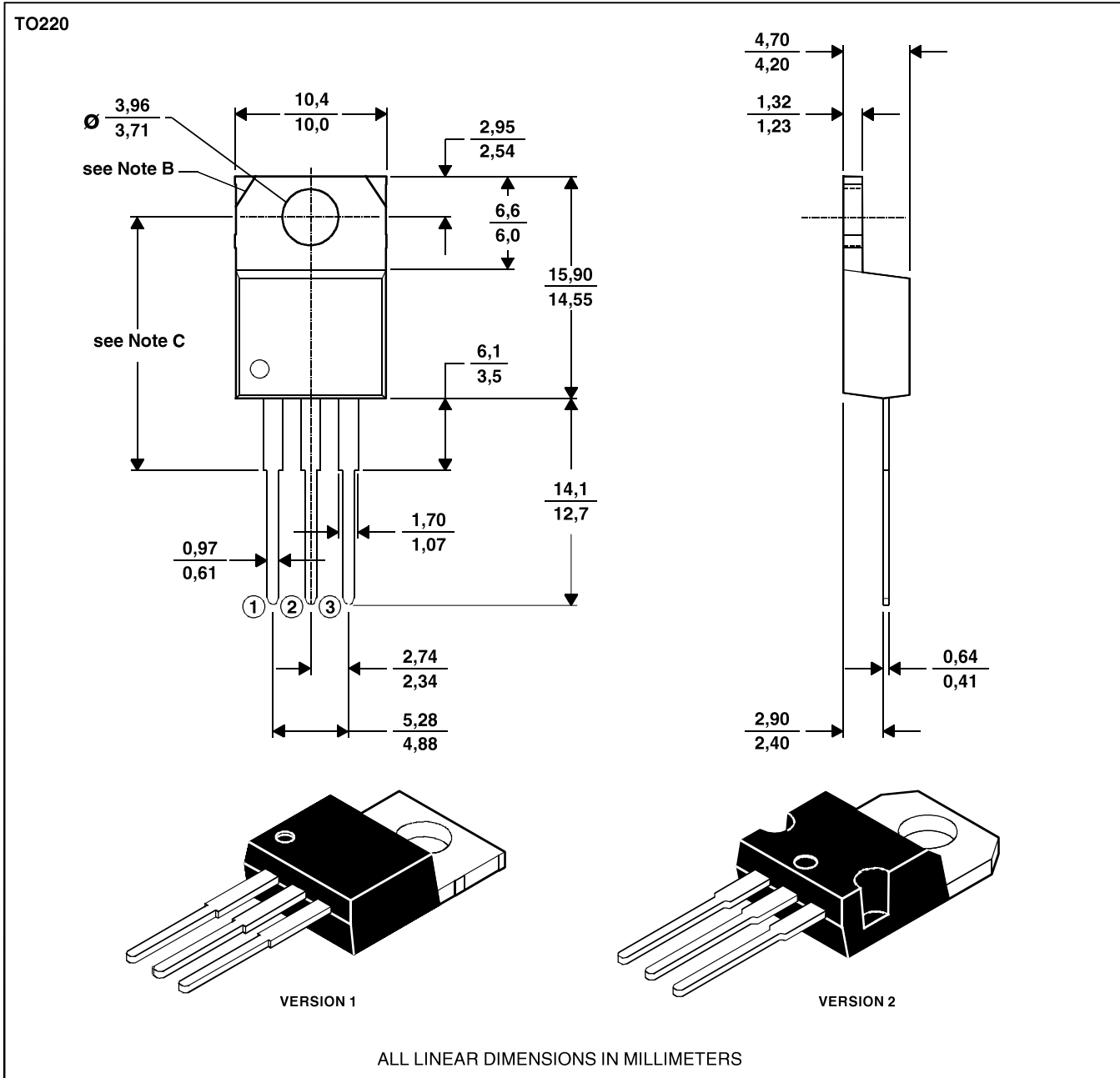
# BUL791 NPN SILICON POWER TRANSISTOR

## MECHANICAL DATA

### TO-220

#### 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



- NOTES: A. The centre pin is in electrical contact with the mounting tab.  
 B. Mounting tab corner profile according to package version.  
 C. Typical fixing hole centre stand off height according to package version.  
 Version 1, 18.0 mm. Version 2, 17.6 mm.